

XP132A01A0SR



Power MOS FET

◆P-Channel Power MOS FET

◆DMOS Structure

◆Low On-State Resistance: 0.105Ω (max)

◆Ultra High-Speed Switching

◆SOP-8 Package

■General Description

The XP132A01A0SR is a P-Channel Power MOS FET with low on-state resistance and ultra high-speed switching characteristics.

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy.

The small SOP-8 package makes high density mounting possible.

■Applications

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

■Features

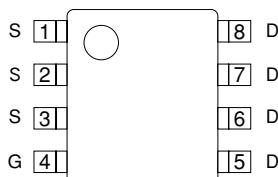
Low on-state resistance : $R_{ds(on)}=0.075\Omega(V_{gs}=-10V)$
: $R_{ds(on)}=0.105\Omega(V_{gs}=-5.5V)$

Ultra high-speed switching

Operational Voltage : -5.5V

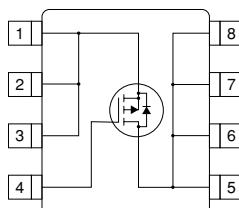
High density mounting : SOP-8

■Pin Configuration



SOP-8
(TOP VIEW)

■Equivalent Circuit



P-Channel MOS FET
(1 device built-in)

■Pin Assignment

PIN NUMBER	PIN NAME	FUNCTION
1 ~ 3	S	Source
4	G	Gate
5 ~ 8	D	Drain

■Absolute Maximum Ratings

T_a=25°C

PARAMETER	SYMBOL	RATINGS	UNITS
Drain-Source Voltage	V _{dss}	-30	V
Gate-Source Voltage	V _{gss}	±20	V
Drain Current (DC)	I _d	-5	A
Drain Current (Pulse)	I _{dp}	-15	A
Reverse Drain Current	I _{dr}	-5	A
Continuous Channel Power Dissipation (note)	P _d	2.5	W
Channel Temperature	T _{ch}	150	°C
Storage Temperature	T _{stg}	-55~150	°C

Note: When implemented on a glass epoxy PCB

■ Electrical Characteristics

DC Characteristics

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Drain Cut-off Current	Idss	Vds=-30V, Vgs=0V			-10	µA
Gate-Source Leakage Current	Igss	Vgs=±20V, Vds=0V			±10	µA
Gate-Source Cut-off Voltage	Vgs(off)	Id=-1mA, Vds=-10V	-1.0		-2.5	V
Drain-Source On-state Resistance (note)	Rds(on)	Id=3A, Vgs=-10V			0.075	Ω
		Id=1A, Vgs=-5.5V			0.105	Ω
Forward Transfer Admittance (note)	Yfs	Id=3A, Vds=-10V		5		S
Body Drain Diode Forward Voltage	Vf	If=-5A, Vgs=0V		-0.85	-1.1	V

Note: Effective during pulse test.

Dynamic Characteristics

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Capacitance	Ciss	Vds=-10V, Vgs=0V f=1MHz		780		pF
Output Capacitance	Coss			560		pF
Feedback Capacitance	Crss			200		pF

Switching Characteristics

Ta=25°C

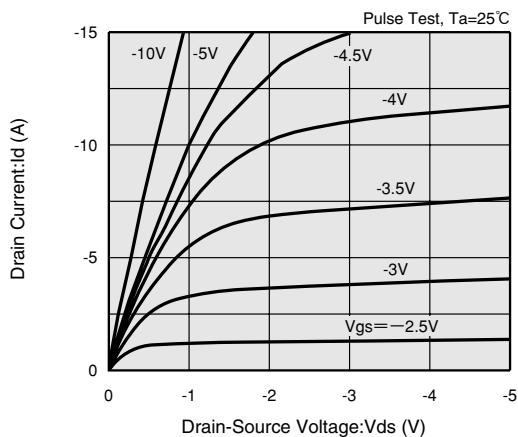
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Turn-on Delay Time	td (on)	Vgs=-5V, Id=3A Vdd=-10V		20		ns
Rise Time	tr			25		ns
Turn-off Delay Time	td (off)			30		ns
Fall Time	tf			20		ns

Thermal Characteristics

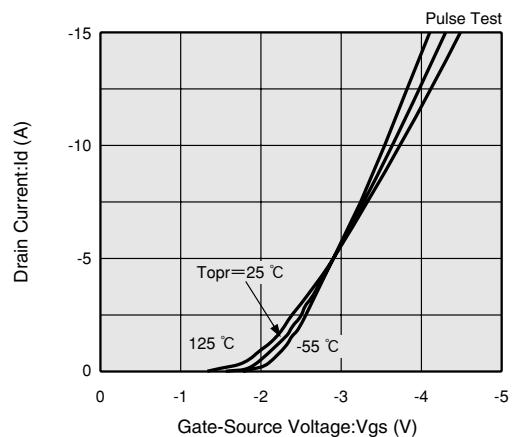
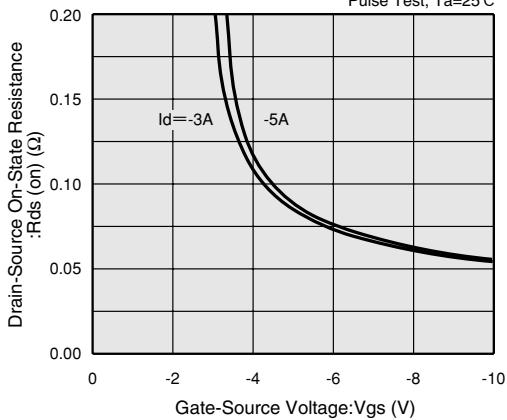
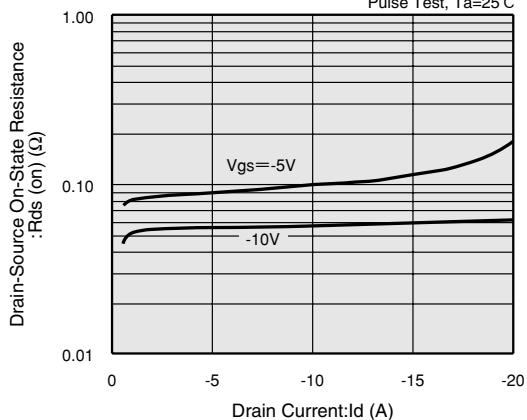
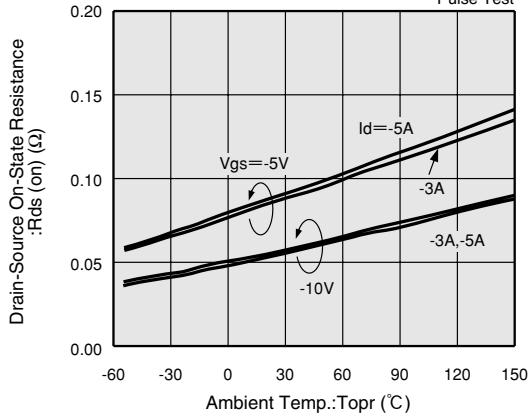
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Thermal Resistance (channel-ambience)	Rth (ch-a)	Implement on a glass epoxy resin PCB		50		°C/W

■ Typical Performance Characteristics

DRAIN CURRENT vs. DRAIN-SOURCE VOLTAGE



DRAIN CURRENT vs. GATE-SOURCE VOLTAGE

DRAIN-SOURCE ON-STATE RESISTANCE
vs. GATE-SOURCE VOLTAGEDRAIN-SOURCE ON-STATE RESISTANCE
vs. DRAIN CURRENTDRAIN-SOURCE ON-STATE RESISTANCE
vs. AMBIENT TEMPERATUREGATE-SOURCE CUT-OFF VOLTAGE VARIANCE
vs. AMBIENT TEMPERATURE